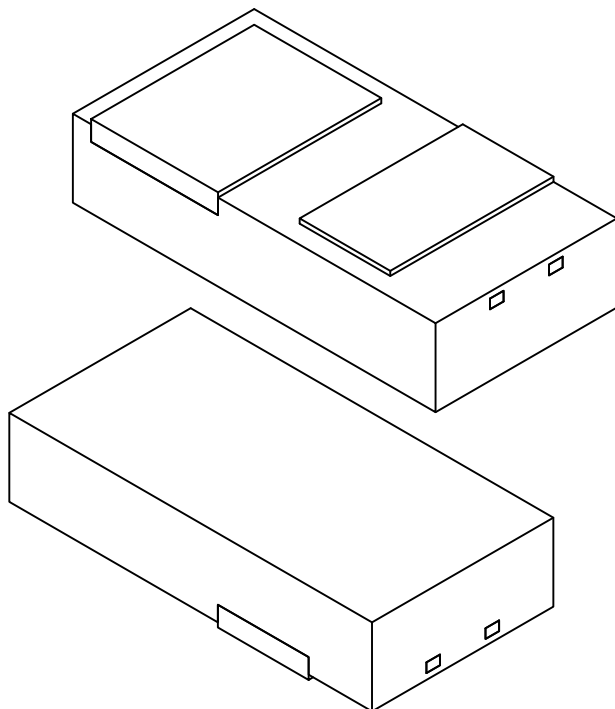


2-Lead Very Thin Single Flat, No Lead Package (LYB) - 2x4 mm Body [VSFN] Atmel Legacy Global Package Code RWX

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



		MILLIMETERS		
Units				
Dimension Limits		MIN	NOM	MAX
Number of Terminals	N	2		
Pitch	e	1.90 BSC		
Terminal 1 Center to Body Center	e1	1.10 BSC		
Overall Height	A	0.80	0.85	0.90
Standoff	A1	-	-	0.05
Overall Length	D	2.00 BSC		
Overall Width	E	4.00 BSC		
Terminal 1 Width	b	1.35	1.40	1.45
Terminal 2 Width	b1	0.95	1.00	1.05
Terminal Length	L	1.75	1.80	1.85

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Package is saw singulated
- Dimensioning and tolerancing per ASME Y14.5M
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.